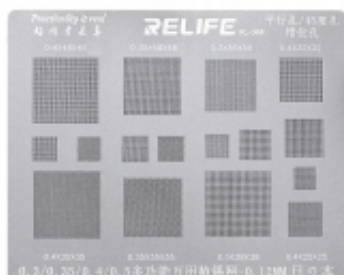


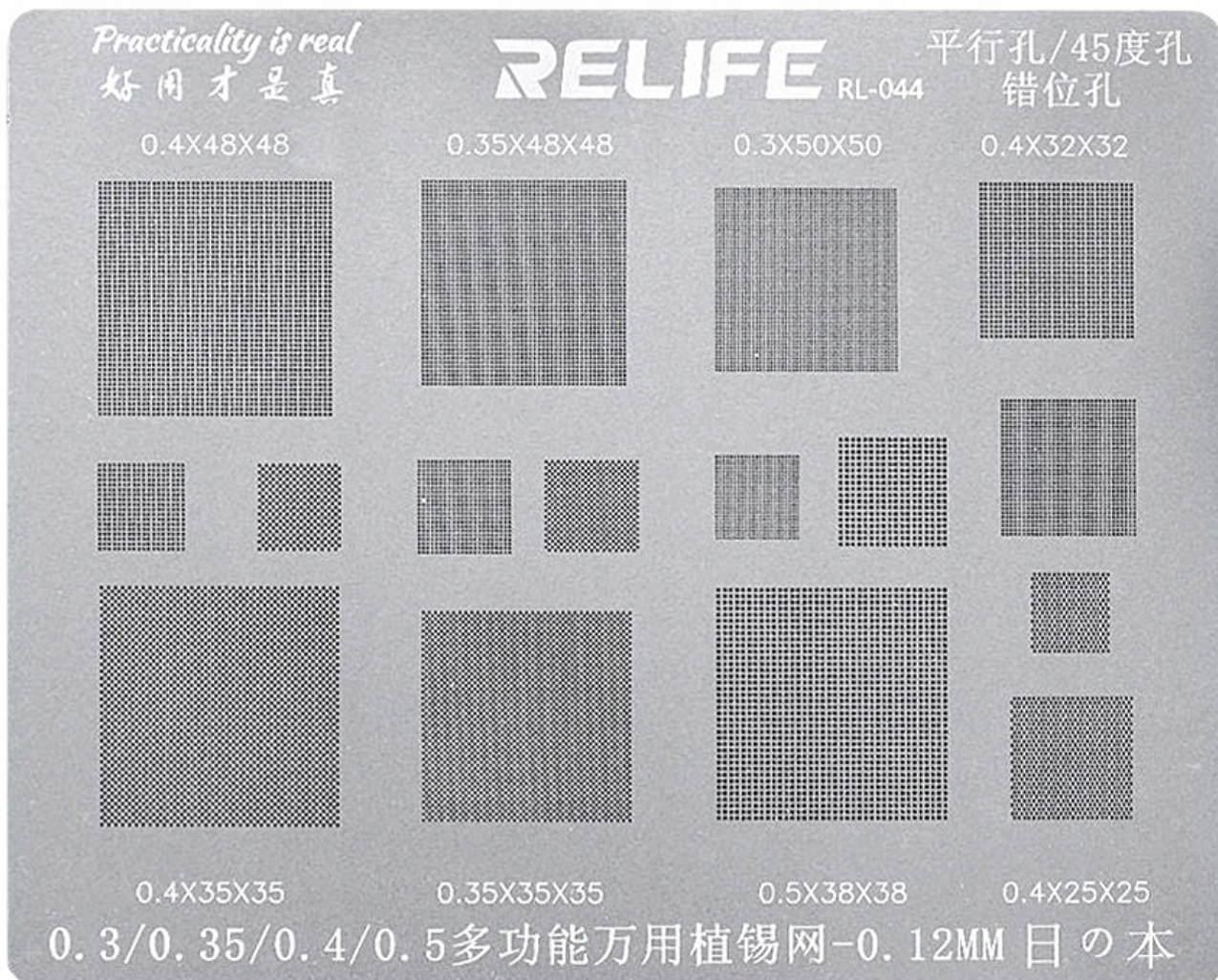
Link do produktu: <https://serwisowe.pl/sito-matryca-bgap-universalne-do-past-lutowniczych-0-3-0-5-relife-rl-044-p-644.html>

SITO MATRYCA BGAP UNIWERSALNE DO PAST LUTOWNICZYCH 0,3 - 0,5 RELIFE RL-044

Cena brutto	24,19 zł
Cena netto	19,67 zł
Dostępność	Dostępny
Czas wysyłki	24 godziny
Numer katalogowy	XSLU0000972
Kod EAN	6949639144270

Opis produktu

XSLU0000972



UNIWERSALNE SITO/MATRYCA BGA PLATE

RELIFE RL-044

UWAGA:

Sito przeznaczone jest **do nakładania pasty lutowniczej!**

Maksymalna temp. dla sit przeznaczonych do bezpośredniego grzania to 280C.

Parametry sita:

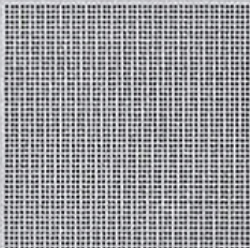
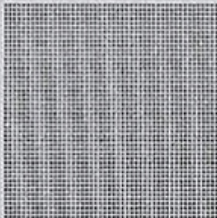
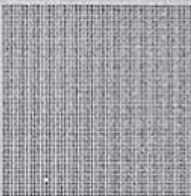
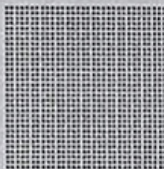



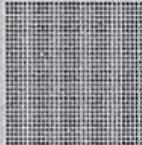
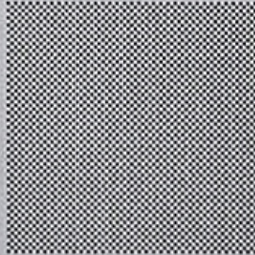

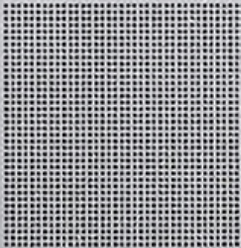

- sita: 0.3, 0.35, 0.4, 0.5mm
- grubość: 0,12mm

- waga netto: 5g
- materiał: stal

Wszelkie reklamacje z tytułu przegrzania sita temperaturami wyższymi będą odrzucane!

Practicality is real
好用才是真

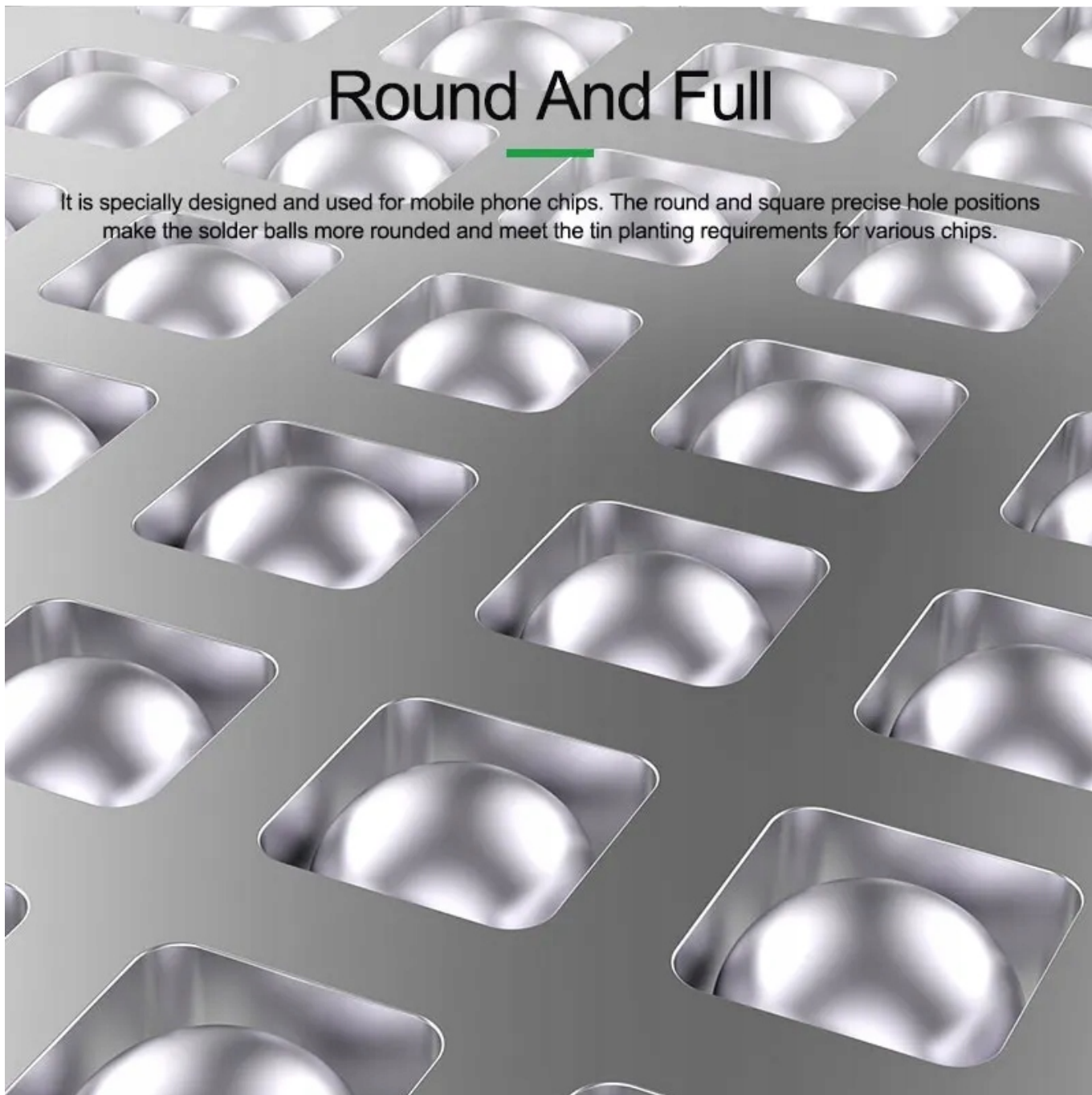
RELIFE RL-044 平行孔/45度孔
错位孔

0.4X48X48	0.35X48X48	0.3X50X50	0.4X32X32
			
			
			
0.4X35X35	0.35X35X35	0.5X38X38	0.4X25X25

0.3/0.35/0.4/0.5多功能万用植锡网-0.12MM 日の本

Round And Full

It is specially designed and used for mobile phone chips. The round and square precise hole positions make the solder balls more rounded and meet the tin planting requirements for various chips.





01



High temperature and wear resistance

High-quality special steel is selected, which has good high temperature resistance and metal fatigue resistance, so that each tin point is heated evenly

Precision hole pitch design

The round and square precise hole position makes the solder balls more rounded and prevents the mesh holes from jamming the solder balls

02

